05-01-1998

FORM PTO- 1595 1-31-92	U.S. DEPARTMENT OF COMM	
To the Assistant Commissioner of Patents		
Name of conveying party(ies):	2. Name and address of receiving party(ies):	
NOBUYUKI KIHARA and HIRAKU INOUE	Name: SONY CORPORATION	
	Internal Address: Tokyo International P.O. Box 5100, Tokyo	
Additional name(s) of conveying party(ies) attached?  Yes  X No	Street Address: 7-35, Kitashinagawa 6-chome, Shinagawa-k	
3. Nature of Conveyance:	City Tokyo 141 Country Japan	
X Assignment	Additional Name(s) & address(es) attached?  Yes X No	
i. Application number(s) or patent number(s):		
A. Patent Application No.(s): 08/987,302 Filed: December 9, 1997	B. Patent No.(s)	
Additional numbers attached? (	Yes X No	
<ul> <li>Name and address of party to whom correspondence concern document should be mailed:</li> <li>Name: Charles P. Sammut, Esquire</li> </ul>	6. Total number of applications and patents involved: 1 7. Total fee (37 CFR 3.41):\$ 40.00	
Internal Address: Limbach & Limbach L.L.P.		
Street Address: 2001 Ferry Building City, State, ZIP: San Francisco, California 94111	<ul><li>X Enclosed</li><li>Authorized to be charged to deposit account</li></ul>	
Telephone: (415) 433-4150 Facsimile: (415) 433-8716	8. Deposit account number: 12-1420	
Attorney Docket No. SONY-6400	(Attach duplicate copy of this page if paying by deposit account)	
14/30/1998 DCOATES 00000172 08987302 DO NOT U	SE THIS SPACE	
7. Statement and signature.		
•	the and correct and any attached copy is a true copy of the original document.	
Charles P. Sammut Name of Person Signing	Signature April 14, 1998 Date	
	Total number of pages comprising cover sheet:	
DMB No. 0651-0011 (exp 4/94)		
Do not d	letach this portion	
Mail documents to be recorded with required cover sheet information to:		
Вох	f Patents and Trademarks Assignments gton, D.C. 20231	
Public burden reporting for this sample cover sheet is estimated to average document and gathering the data needed, and completing and reviewing to	ge about 30 minutes per document to be recorded, including time for reviewing the the sample cover sheet. Send comments regarding this burden estimate to the U.S. Washington, D.C. 20213, and to the Office of Management and Budget, Paperwork	

Docket Number: SONY-6400

## ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in METHOD AND APPARATUS FOR CHECKING COMPRESSED DATA ERRORS

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 08/987,302 Filing Date: December 9, 1997.

This assignment executed on the dates indicated below.

NOBUYUKI KIHARA	March 9, 1998
Name of first or sole inventor	Execution date of U.S. Patent Application
TOKYO, JAPAN	
Residence of first or sole inventor	
Nobayaki Kihara Signature of first or sole inventor	March 9, 1998
Signature of first or sole inventor	Date of this assignment

## S97P1115US00

HIRAKU INOUE	Klowch, 9 1998
Name of second inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	
Residence of second inventor	16 X (2011) 8 1992
Signature of second inventor	Desc of this essignment
Name of third inventor	Execution date of U.S. Patent Application
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Name of fourth inventor	Execution date of U.S. Patent Application
Residence of fourth inventor	
Signature of fourth inventor	Date of this essignment
Name of fifth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	
Signature of fifth Laveator	Date of this essignance

PATENT REEL: 9286 FRAME: 0209